



Applicants:

Dalton et al.

Title:

Formation of Low Resistance Via Contacts in Interconnect

Structures

Filed:

September 19, 2003

Serial No:

10/665,584

Docket No.:

YOR920030247US1

Examiner:

Thomas L. Dickey

Art Unit:

2826

Confirmation No.:

5258

Customer No.:

27623

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

<u>AMENDMENT</u>

Dear Sir:

In response to the Office Action dated October 5, 2004, please amend this application as follows:

DAW